

PIN 1 REFERENCE

XDFNW3 1.00x1.00x0.38 0.65P CASE 521AC

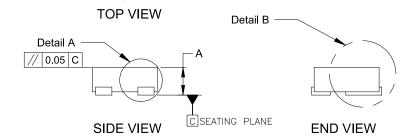
ISSUE B

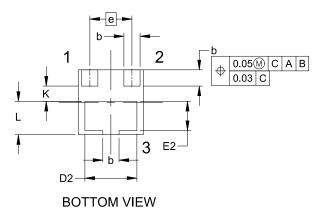
DATE 07 MAY 2024

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
- 2. CONTROLLING DIMENSION: MILLIMETERS

	MILLIMETERS		
DIM	MIN.	NOM.	MAX.
Α	0.32	0.38	0.44
A1	0.00		0.04
А3	0.125 REF		
b	0.20	0.25	0.30
D	0.90	1.00	1.10
D1	0.00		0.04
D2	0.75	0.80	0.85
E	0.90	1.00	1.10
E2	0.40	0.45	0.50
е	0.65 BSC		
L	0.465	0.515	0.565
K	0.23 REF		

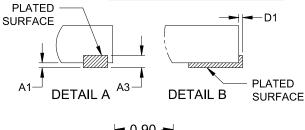


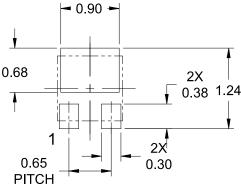


GENERIC MARKING DIAGRAM*



XX = Specific Device Code = Month Code NΛ





RECOMMENDED **MOUNTING FOOTPRINT***

For additional information on our Pb-Free strategy and soldering details, please download the ONSEMI Soldering and Mounting Techniques Reference Manual, S●LDERRM/D.

DESCRIPTION:	XDFNW3 1.00x1.00x0.38 0.65P		PAGE 1 OF 1
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^{*}This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may not follow the Generic Marking.